Product / Process Change Notification



N° 2016-060-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of Infineon Kulim, Malaysia as an additional wafer test location affecting dedicated products

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 1st February 2017.
- Infineon aligns with the widely-recognized JEDEC STANDARD"JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0 Chairman of the Supervisory Board: Wolfgang Mayrhuber Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck Registered Office: Neubiberg Commercial Register Amtsgericht München HRB 126492

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Products affected:	Sales Name	SP N°	OPN	Package
	TLE4906-2K	SP000868840	TLE49062KHTSA1	PG-SC59-3
	TLE4906-3K	SP000868844	TLE49063KHTSA1	PG-SC59-3
	TLE4906K	SP000475028	TLE4906KHTSA1	PG-SC59-3
	TLE4906L	SP000012949	TLE4906LHALA1	PG-SSO-3
	TLE4946-1L	SP000015003	TLE49461LHALA1	PG-SSO-3
	TLE4946-2K	SP000472424	TLE49462KHTSA1	PG-SC59-3
	TLE4946-2L	SP000398352	TLE49462LHALA1	PG-SSO-3
	TLE4946K	SP000392737	TLE4946KHTSA1	PG-SC59-3
	TLI4906K	SP000604306	TLI4906KHTSA1	PG-SC59-3
	TLI4906L	SP000604320	TLI4906LHALA1	PG-SSO-3
	TLI4946-2K	SP000604328	TLI49462KHTSA1	PG-SC59-3
	TLI4946-2L	SP000604336	TLI49462LHALA1	PG-SSO-3
	TLV4906K	SP000604310	TLV4906KFTSA1	PG-SC59-3
	TLV4906L	SP000604324	TLV4906LHALA1	PG-SSO-3
	TLV4946-2K	SP000604332	TLV49462KFTSA1	PG-SC59-3
	TLV4946-2L	SP000604340	TLV49462LHALA1	PG-SSO-3

Detailed Change Information:

Subject:	Introduction of Infineon Kulim, Malaysia as an additional wafer test location affecting dedicated products.			
Reason:	To continuously ensure the delivery capability to our customers, the wafer test capacity will be extended.			
Description:	<u>Old</u>	New		
Wafer test location:	 Infineon Villach, Austria 	 Infineon Villach, Austria or Infineon Kulim, Malaysia 		
Product Identification:	Traceability is ensured by lot number.			
Impact of Change:	No change in form fit or function and no impact on quality and reliability of the final product. The wafer test location verification is performed via the Advanced Measurement System Analysis (AMSA) methodology.			



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Attachments:

None

► Time Schedule:

- Final qualification report:
- First samples available:
- Intended start of delivery:

AMSA assessment is available on demand No samples planned due to no change of product. April 2017

If you have any questions, please do not hesitate to contact your local Sales office.